



# **Product Change Notification**

## **113766 - 01**

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**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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# Product Change Notification

**Change Notification #:** 113766 - 01  
**Change Title:** Intel® Compute Module HNS2600WP & HNS2600WPQ  
PCN 113766-01, Product Design  
Change the material of tray latch cap from rubber to polycarbonate  
**Reason for Revision: Additional Product Added**  
**Date of Publication:** July 15, 2015

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	April 23, 2015
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

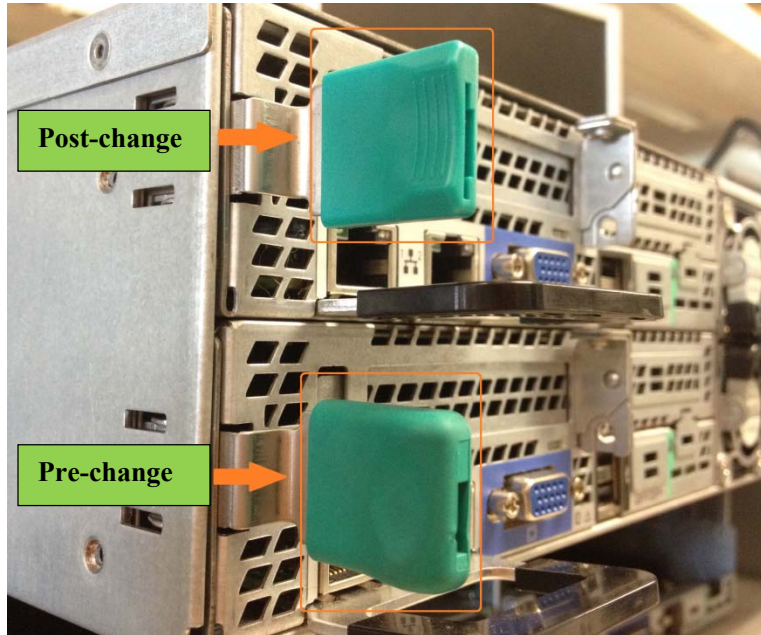
## Description of Change to the Customer:

**Reason for Revision: Additional Product Added**

Intel is implementing the following change on the Intel® Compute Module HNS2600WP & HNS2600WPQ:

Change the material of tray latch cap from rubber to polycarbonate to avoid pulling the cap out from the tray latch.

See below picture: the lower one is pre-change cap and the upper one is post-change cap.



**Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers. Customers may need to validate the function and feature changes after receiving the system.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
HNS2600WP	918378	G43581-005	G43581-006
<a href="#">HNS2600WPQ</a>	<a href="#">918377</a>	<a href="#">G54630-002</a>	<a href="#">G54630-003</a>

**PCN Revision History:**

Date of Revision:	Revision Number:	Reason:
April 6, 2015	00	Originally Published PCN
<a href="#">July 15, 2015</a>	<a href="#">01</a>	<a href="#">Additional product added</a>